

# LED Drivers for High Power LEDs

## ILD6150

60 V / 1.5 A High Efficiency Step-Down LED Driver

### Data Sheet

Revision 3.0, 2013-10-10

Power Management and Multimarket

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## Revision History

Page or Item	Subjects (major changes since previous revision)
<b>Revision 3.0, 2013-10-10</b>	
All	Initial release of final data sheet
<b>Table 4</b>	Typical value of $V_{S, U, off}$ updated Typical value of $V_{S, U, on}$ updated Supply current consumption specified for different supply voltages Typical value of $t_{S, reset}$ updated Typical value of $t_{delay, OCP}$ updated Typical value of $t_{timeout, OCP}$ updated Typical value of $I_{Tadj, short}$ updated
<b>Figure 3</b>	Figure updated
<b>Table 5</b>	Typical value of $V_{sense}$ updated Typical value of $V_{sensehys}$ updated $R_{ON, 125^{\circ}C}$ updated
<b>Table 6</b>	Typical value of $I_{EN, 3V}$ updated
<b>Table 7</b>	Typical value of $t_{d, PWM, off}$ updated
<b>Table 8</b>	Typical value of $V_{PWM, 0\%}$ updated Typical value of $V_{PWM, 50\%}$ updated Typical value of $D.C./V_{PWM}$ updated
<b>Figure 5</b>	Figure updated

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## 60 V / 1.5 A High Efficiency Step-Down LED Driver

### 1 Features

- Wide input voltage range from 4.5 V to 60 V
- Capable to provide up to 1.5 A average output current
- Up to 1 MHz switching frequency
- Soft-start capability
- Separate enable and PWM dimming pins
- Analog and PWM dimming possible
- Integrated PWM generator for analog dimming input
- Typical 3% output current accuracy
- Very low LED current drift over temperature
- Adjustable over-temperature protection
- Undervoltage lockout
- Over-current protection
- Thermally optimized package: PG-DSO-8-27



### Applications

- LED driver for general lighting
- Retail, office and residential downlights
- Street and tunnel lighting
- LED ballasts



Product Name	Package	Marking
ILD6150	PG-DSO-8-27	ILD6150



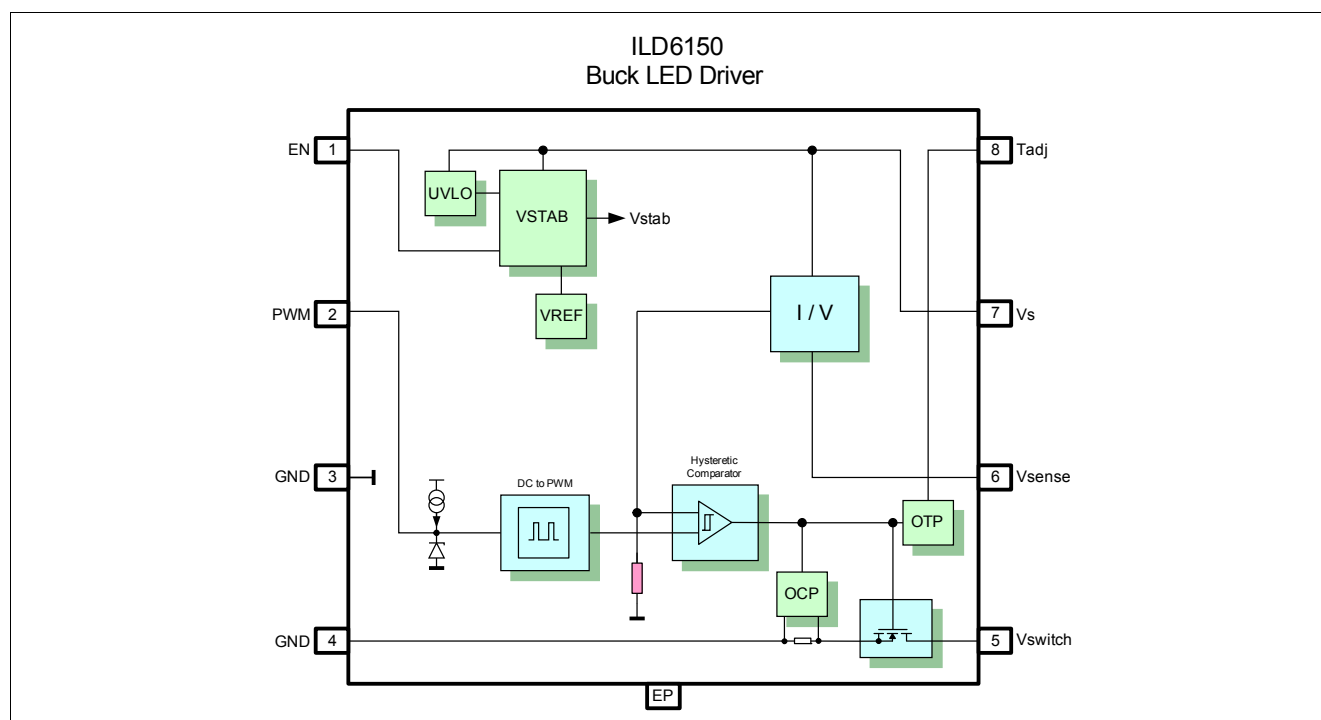
## 2 Product Brief

The ILD6150 is a hysteretic buck LED driver IC for driving high power LEDs in general lighting applications with average currents up to 1.5 A.

The ILD6150 is suitable for LED applications with a wide range of supply voltages from 4.5 V to 60 V. The enable signal can be used to activate the standby mode. A multifunctional PWM input signal allows dimming of the LEDs with an analog DC voltage or an external PWM signal. To minimize colorshifts of the LEDs an analog PWM voltage is converted to an internal 1.6 kHz PWM signal modulating the LED current.

The ILD6150 incorporates an undervoltage lock-out that will shut down the IC when the minimum supply voltage threshold is exceeded. The over-current protection turns off the output stage once the output current is above the current threshold. An integrated over-temperature protection circuit will start to reduce the LED current by internal PWM modulation once the adjustable junction temperature threshold of the IC is exceeded. Realizing a thermal coupling between LED driver and LEDs this feature eliminates the need of external temperature sensors as NTCs or PTCs.

Thanks to the hysteretic concept the current control is extremely fast and always stable. A maximum contrast ratio of 3000:1 can be achieved depending of the dimensioning of the external components. The efficiency of the LED driver is remarkable high, reaching up to 98% of efficiency over a wide range. The output current accuracy from device to device and under all load conditions and over temperature is limited to a minimum, making ILD6150 the perfect fit for LED ballasts.



**Figure 1 Block Diagram**

## Pin Definition

**Table 1 Pin Definition and Function**

Pin No.	Name	Pin Type	Buffer Type	Function
1	EN	Input	–	<b>IC enable signal</b>
2	PWM	Input	–	<b>Dimming signal:</b> <ul style="list-style-type: none"> <li>Analog dimming</li> <li>PWM dimming</li> </ul>
3	GND	GND	–	<b>IC ground</b>
4	GND	GND	–	<b>IC ground</b>
5	Vswitch	Output	–	<b>Power switch output</b>
6	Vsense	Input	–	<b>LED current sense input</b>
7	VS	Input	–	<b>Supply voltage</b>
8	Tadj	Output	–	<b>Over-temperature adjustment</b>
EP	Exposed Pad	GND	–	<b>IC ground and heat spreader</b>

### 3 Maximum Ratings

**Table 2 Maximum Ratings**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_S$	-0.3	–	60	V	–
EN voltage	$V_{EN}$	-0.3	–	60	V	–
PWM voltage	$V_{PWM}$	-0.3	–	5.5	V	–
Tadj voltage	$V_{Tadj}$	-0.3	–	3.5	V	–
Sense voltage	$V_{sense}$	$V_S - 0.3$	–	$V_S$	V	–
Switch voltage	$V_{switch}$	-0.3	–	60	V	–
Average switch output current	$I_{out}$	–	–	1.5	A	–
Total power dissipation, $T_S \leq 116^\circ\text{C}$	$P_{tot}$	–	–	2	W	–
Junction temperature	$T_J$	-40	–	150	$^\circ\text{C}$	–
Storage temperature range	$T_{STG}$	-65	–	150	$^\circ\text{C}$	–
ESD capability at all pins <sup>1)</sup>	$V_{ESD\ HBM}$	–	–	2	kV	HBM acc. to JESD22 - A114

1) Two different classes of ESD protection elements are implemented within ILD6150:

- ESD protection at pin 7 ( $V_S$ ) gets triggered once the slew rate of the applied voltage signal exceeds a threshold of approximately 10 V/ns. In this case ESD protection will be triggered independently from the applied voltage level and won't turn off until supply voltage gets zero. If ESD protection gets triggered while  $V_S$  is supplied the ESD protection respective the IC might be damaged. Therefore a  $V_S$  blocking capacitor close to pin 7 is required to keep the slew rate at pin 7 below the threshold and to filter events as turning on the supply voltage or  $V_S$  voltage spikes.
- ESD protection at all other pins is triggered once the connected voltage signal exceeds a threshold higher than the maximum voltage rating specified for each pin. No preventions regarding slew rate control need to be taken for these pins.

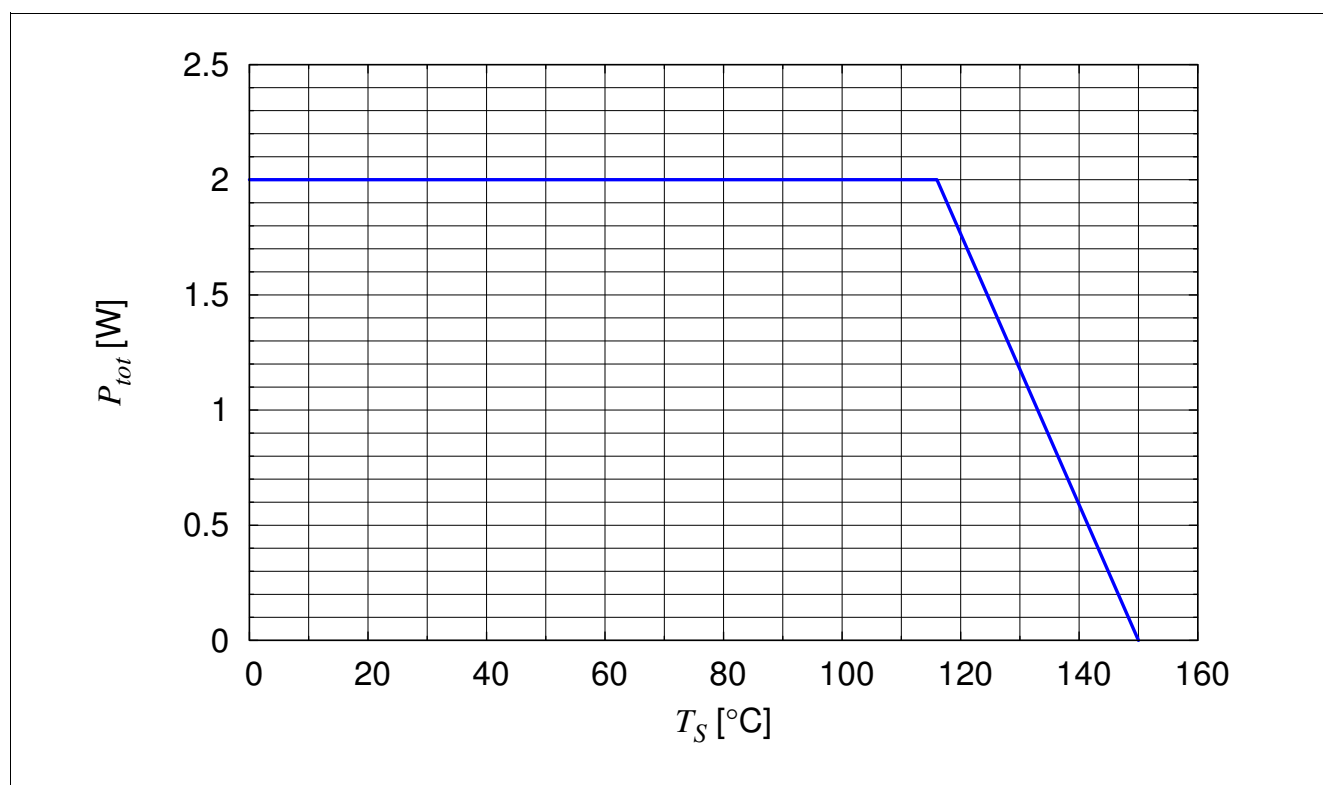
**Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.**

## 4 Thermal Characteristics

**Table 3 Maximum Thermal Resistance**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	–	17	–	K/W	–

1) For calculation of  $R_{thJA}$  please refer to application note AN077 (Thermal Resistance Calculation)



**Figure 2 Total Power Dissipation**

The major part of the IC power dissipation is caused by the switch resistance in conductive state. Therefore [Equation \(1\)](#) is a first estimation to calculate the total power dissipation of the IC

$$P_{tot} = R_{ON} \cdot I_{out}^2 \cdot D + I_S \cdot V_S \quad (1)$$

$D$ : Duty cycle of the output switch

For a more precise analysis measure the soldering point temperature  $T_S$  of ILD6150 at GND pin and use [Figure 2](#) as a reference.

## 5 Electrical Characteristics

### 5.1 DC Characteristics

All parameters at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified.

**Table 4 DC Characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Operating supply voltage	$V_S$	4.5	–	60	V	–
Under Voltage Lock Out	$V_{S, UV, off}$	4.05	4.25	4.45	V	IC deactivated <sup>1)</sup>
	$V_{S, UV, on}$	4.15	4.35	4.50	V	IC operative
Supply current consumption open load $V_S = V_{sense}$ , $I_{LED} = 0\text{ mA}$	$I_{S, OL, 4.5V}$	1.55	2.1	2.65	mA	$V_S = 4.5\text{ V}$
	$I_{S, OL, 12V}$	1.60	2.2	2.70	mA	$V_S = 12\text{ V}$
	$I_{S, OL, 60V}$	1.60	2.24	2.80	mA	$V_S = 60\text{ V}$
Supply voltage reset time	$T_{S, reset}$	105	160	210	$\mu\text{s}$	Reset time after $V_S$ power up <sup>2)</sup>
Supply standby current consumption	$I_{S, stby, 12V}$	–	0.2	–	mA	$V_S = V_{sense} = 12\text{ V}$ $V_{EN} = 0\text{ V}$
	$I_{S, stby, 60V}$	–	0.5	–	mA	$V_S = V_{sense} = 60\text{ V}$ $V_{EN} = 0\text{ V}$
Current of $V_{sense}$ input	$I_{sense}$	12	17	22	$\mu\text{A}$	At any LED current
Output over current protection threshold	$I_{out, OCP}$	2.2	2.5	2.9	A	
Output over current protection delay time	$t_{delay, OCP}$	160	220	300	ns	turn off delay
Output over current protection time out	$t_{timeout, OCP}$	30	57	–	$\mu\text{s}$	turn off duration <sup>3)</sup>
Over temperature protection threshold range (typical), 10 % reduction	$T_{OTP, range}$	75	–	145	$^{\circ}\text{C}$	$R_{Tadj} = 35\text{ k}\Omega \dots 0\text{ }\Omega$ <sup>4)</sup>
Over temperature protection threshold open, 10 % reduction	$T_{OTP, open}$	–	115	–	$^{\circ}\text{C}$	$R_{Tadj} \geq 150\text{ k}\Omega$
Over temperature protection threshold short, 10 % reduction	$T_{OTP, short}$	–	145	–	$^{\circ}\text{C}$	$R_{Tadj} = 0\text{ }\Omega$
Over temperature protection, turn off	$T_{OTP, off}$	–	160	–	$^{\circ}\text{C}$	
Tadj pin current source to GND	$I_{Tadj, short}$	-75	-60	-45	$\mu\text{A}$	$R_{Tadj} = 0\text{ }\Omega$ <sup>5)</sup>

- 1) IC gets deactivated once the supply voltage drops below  $V_{S, UV, off}$  and gets operative once supply voltage rises above  $V_{S, UV, on}$ .
- 2) Reset timer starts after supply voltage exceeds the lower limit of the supply voltage. Output stage gets enabled once reset timer expires.
- 3) Once the over current protection threshold has been exceeded the output switch gets disabled. It's enabled again once the time out expired.
- 4)  $T_{OTP, range}$  specifies the typical temperature tuning range achievable at a 10 % reduction of LED current using resistors with 1 % accuracy. Temperatures specified refer to junction temperature on chip. Accuracy of the temperature sensor is typical  $\pm 5\text{ K}$ . Any resistor value  $R_{Tadj} \geq 0\text{ }\Omega$  can be selected for but it might not influence OTP temperature if out of the ranges specified.
- 5) Definition of current reference: Currents flowing out of the IC have a negative magnitude.

ILD6150 has an integrated over temperature protection based upon the junction temperature on chip. The threshold of the over temperature protection circuit is tuneable by resistor  $R_{Tadj}$  connected from pin Tadj to GND.  $R_{Tadj}$  resistor values within 0 to 35 k $\Omega$  define the over temperature protection behaviour as shown in Figure 5.  $R_{Tadj}$  values  $\geq 150$  k $\Omega$  set the OTP threshold to  $T_{OTP, open}$ . The over temperature protection is based upon modulation of the LED current with an internal PWM generator. Once the junction temperature exceeds the OTP threshold the PWM duty cycle as well as the average LED current will get reduced. Once junction temperature reaches  $T_{OTP, off}$  the PWM duty cycle and LED current will be reduced to zero.

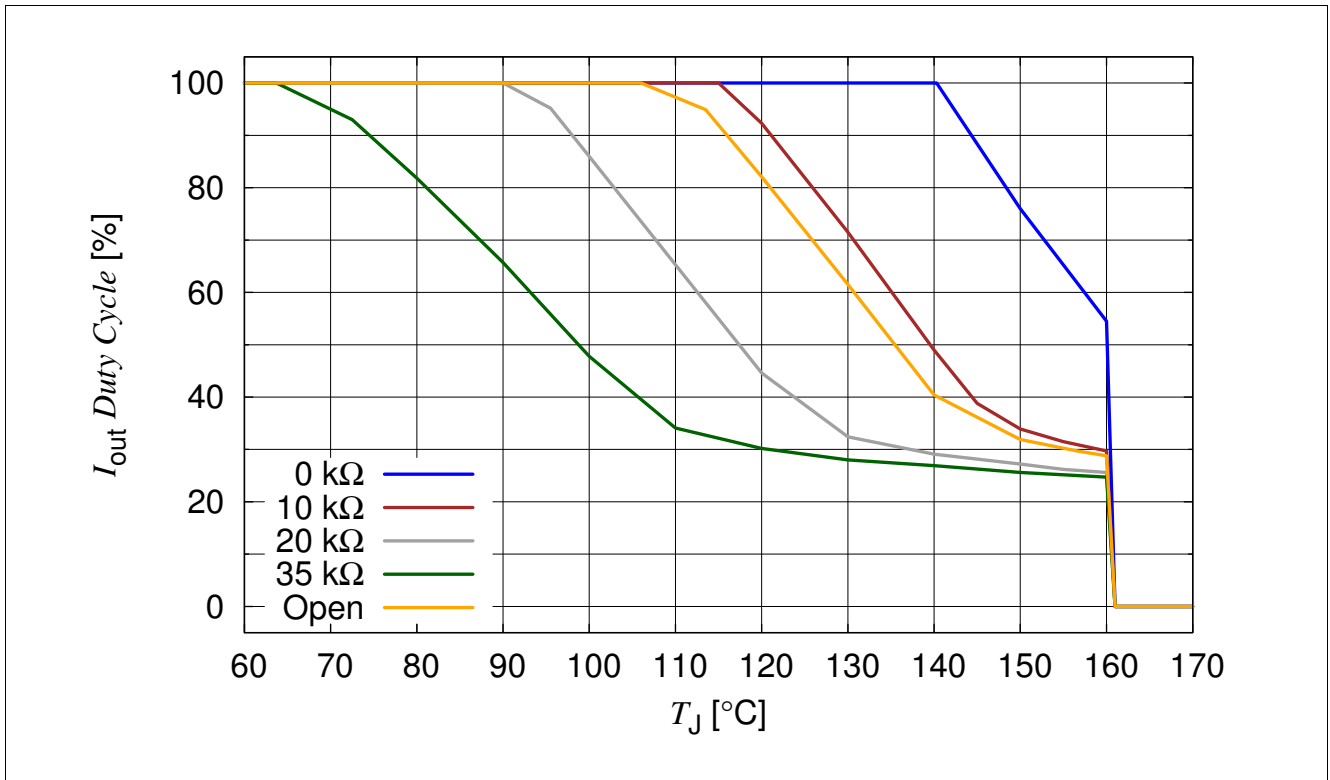


Figure 3 Typical Output Current Duty Cycle of Over Temperature Protection vs.  $T_J$  and  $R_{Tadj}$

## 5.2 Switching Characteristics

All parameters at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified.

**Table 5 Switching Characteristics**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Switching frequency	$f_{switch}$	–	–	1	MHz	
Mean current sense threshold voltage	$V_{sense}$	–	152	–	mV	$f_{switch} = 100\text{ kHz}$
Sense threshold hysteresis	$V_{sensehys}$	–	$\pm 22$	–	%	peak to average $V_S = 12\text{ V}$ $f_{switch} = 100\text{ kHz}$
Output current variation over supply voltage	$I_{out, V_S}$	–	$\pm 3$	–	%	
Output current variation over temperature	$I_{out, T_S}$	–	$\pm 4$	–	%	for temperatures below OTP threshold
Output current variation over load	$I_{out, load}$	–	$\pm 3$	–	%	fixed $V_S$
Switch on resistance	$R_{ON, 25^{\circ}\text{C}}$	0.2	0.23	0.26	$\Omega$	$I_{SW} = 1\text{ A}, T_J = 25\text{ }^{\circ}\text{C}$
	$R_{ON, 125^{\circ}\text{C}}$	0.29	0.34	0.39	$\Omega$	$I_{SW} = 1\text{ A}, T_J = 125\text{ }^{\circ}\text{C}$

### 5.3 Digital Control Signals

All parameters at  $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified.

**Table 6 Digital Control Parameter at Enable Pin EN<sup>1)</sup>**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
EN voltage logic high level	$V_{EN, high}$	2.5	–	60	V	IC operative
EN voltage logic low level	$V_{EN, low}$	-0.3	–	0.5	V	IC in standby
Input current of EN pin	$I_{EN, 3V}$	7	11	15	$\mu\text{A}$	$V_{EN} = 3\text{ V}$
	$I_{EN, 60V}$	35	55	70	$\mu\text{A}$	$V_{EN} = 60\text{ V}$

1) EN pin doesn't have an internal biasing and requires connection to an external voltage signal for operation

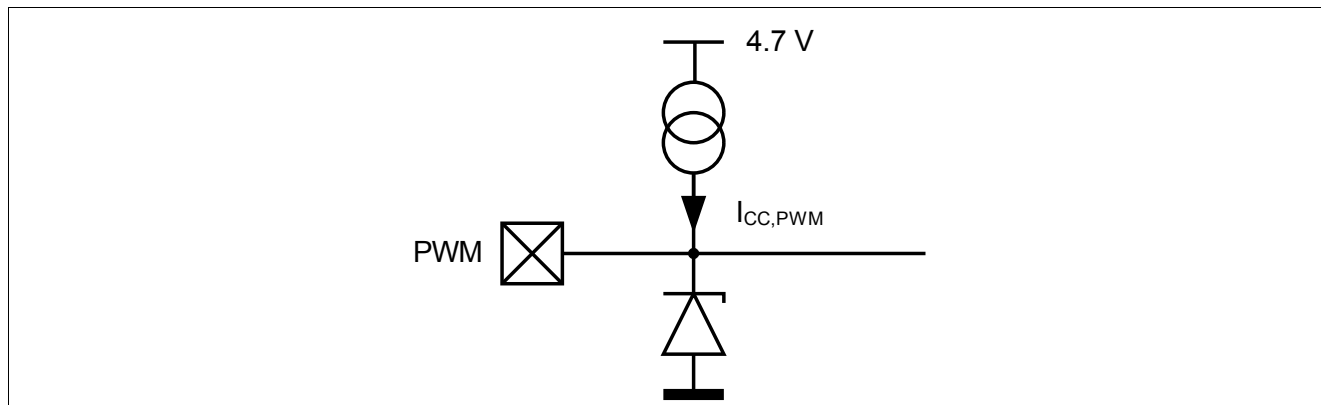
Dimming of the LED current can be achieved by an analog or digital input voltage connected to pin PWM. A digital input signal will modulate the LED current according to [Table 7](#).

**Table 7 Digital Control Parameter at Pin PWM<sup>1)</sup>**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
PWM voltage logic high level	$V_{PWM, high}$	2.6	–	5.5	V	output stage enabled
PWM voltage logic low level	$V_{PWM, low}$	-0.3	–	0.5	V	output stage disabled
PWM output current	$I_{CC, PWM}$	-23	-18	-12	$\mu\text{A}$	$V_{PWM} = 0\text{ V}$
PWM delay time	$t_{d, PWM, on}$	–	0.8	–	$\mu\text{s}$	$V_{EN} = 3\text{ V}$ $V_{PWM} = \text{rising to } 2.5\text{ V}$ $V_{switch} = \text{falling to } 1\text{ V}$
	$t_{d, PWM, off}$	–	0.6	–	$\mu\text{s}$	$V_{EN} = 3\text{ V}$ $V_{PWM} = \text{falling to } 0.5\text{ V}$ $V_{switch} = \text{rising to } 1\text{ V}$
PWM signal frequency	$f_{PWM, ext}$	–	–	25	kHz	

1) PWM pin has an internal pull-up circuit to high level if not connected externally on PCB





**Figure 4 PWM Input**

An analog input voltage activates modulation of the LED current by the integrated PWM generator running at frequency  $f_{PWM, int}$ . Its duty cycle corresponds to analog PWM control voltage as shown in [Table 8](#) and [Figure 5](#).

**Table 8 Analog Control Parameter at Pin PWM**

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
PWM input voltage for 0% duty cycle	$V_{PWM, 0\%}$	—	0.61	—	V	
PWM input voltage for 50% duty cycle	$V_{PWM, 50\%}$	—	1.52	—	V	
PWM input voltage for 100% duty cycle	$V_{PWM, 100\%}$	—	2.43	—	V	
Sensitivity of PWM duty cycle vs. PWM input voltage	D.C./ $V_{PWM}$	—	55	—	%/V	
Integrated PWM generator frequency	$f_{PWM, int}$	1.2	1.6	2.1	kHz	

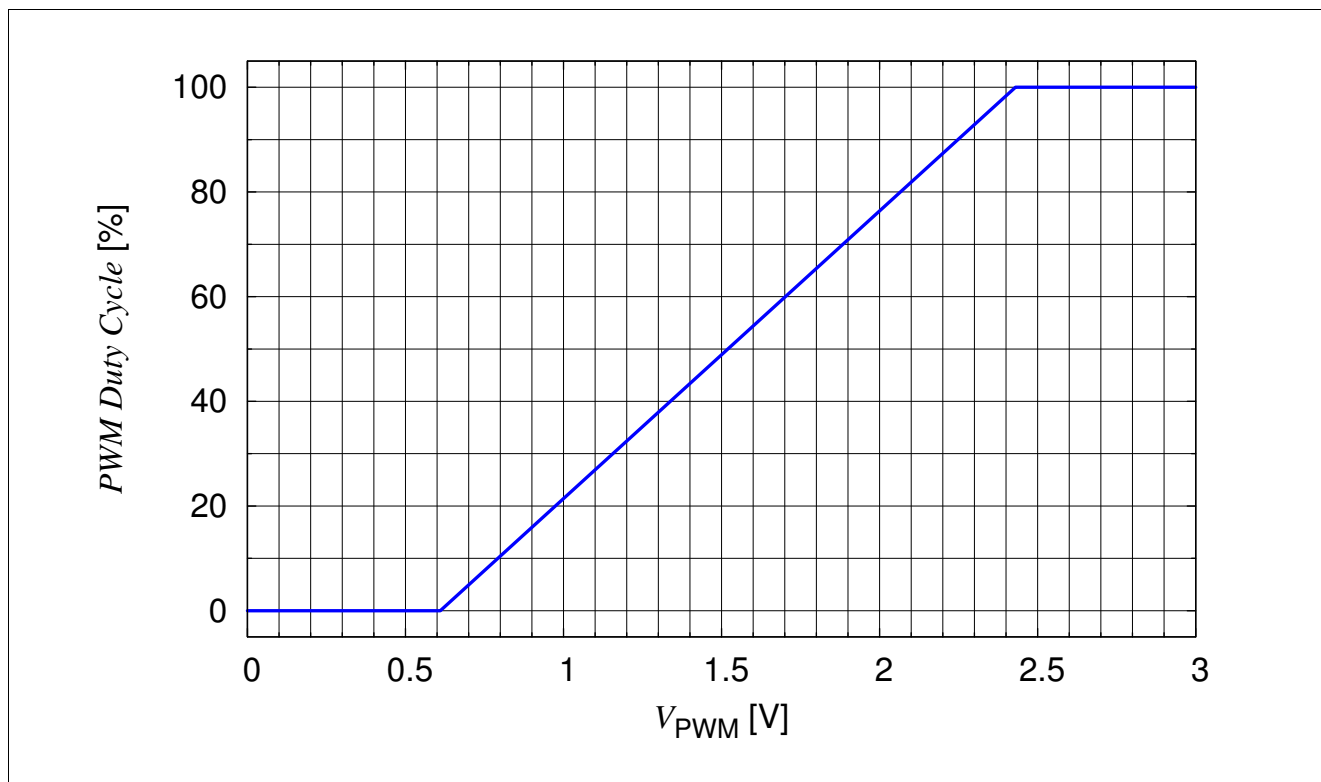
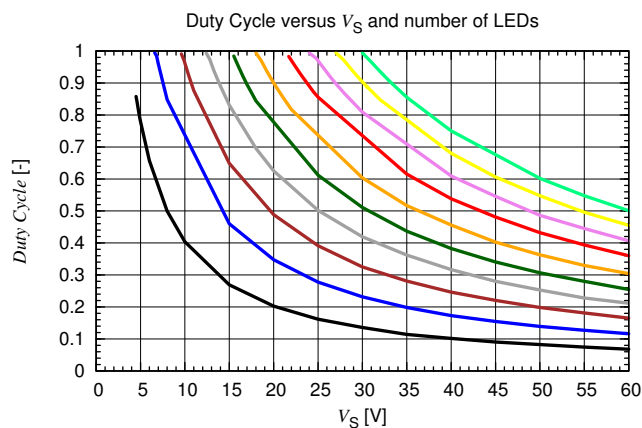
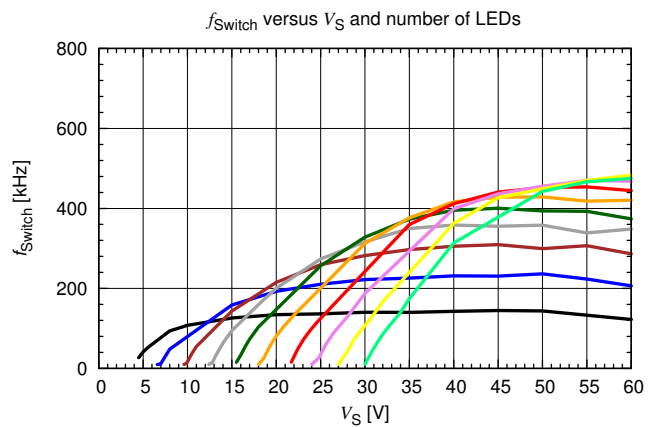
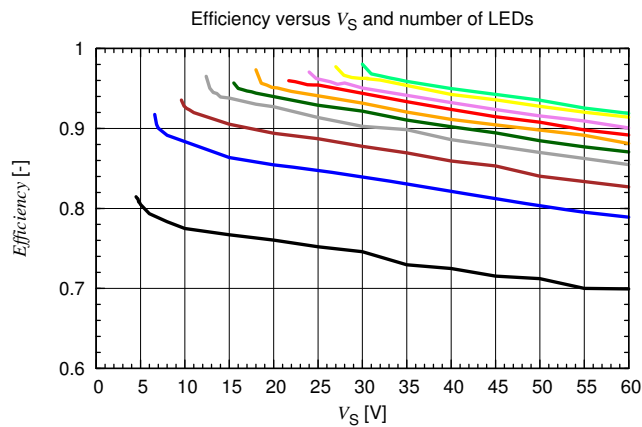
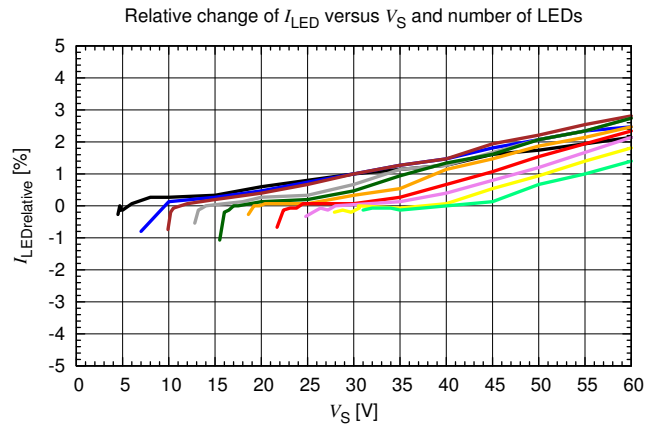
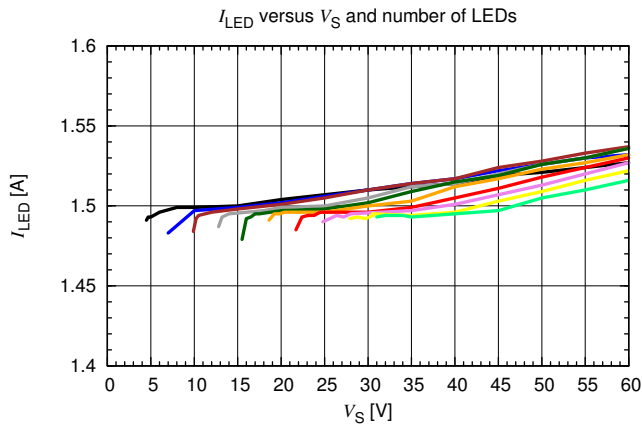


Figure 5 Typical Integrated PWM Duty Cycle vs. PWM Control Voltage

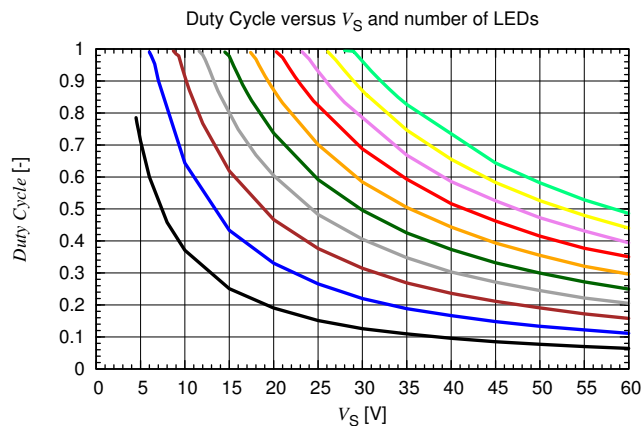
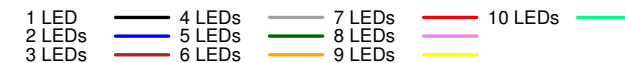
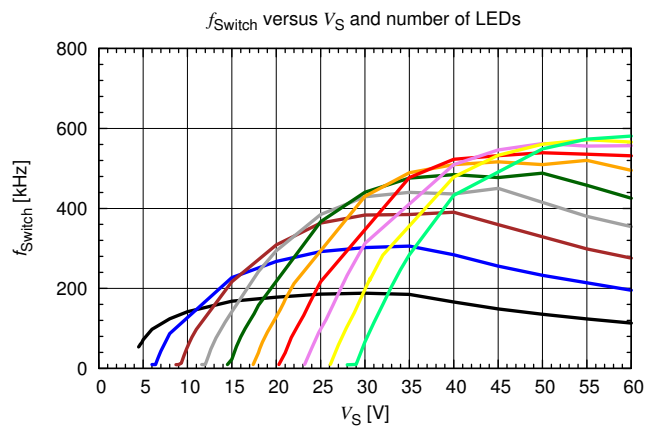
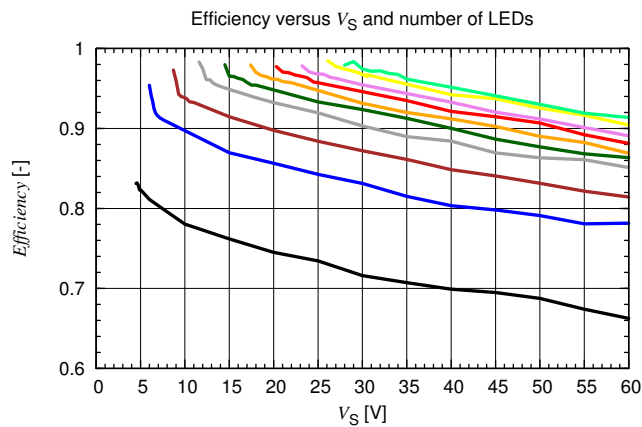
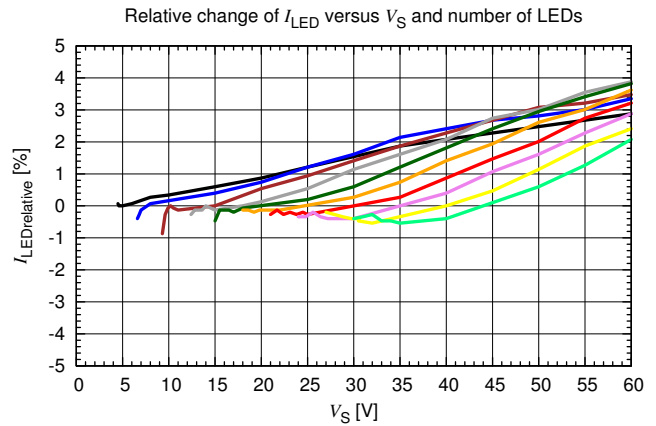
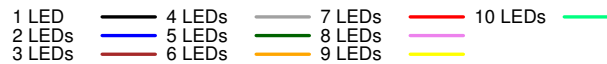
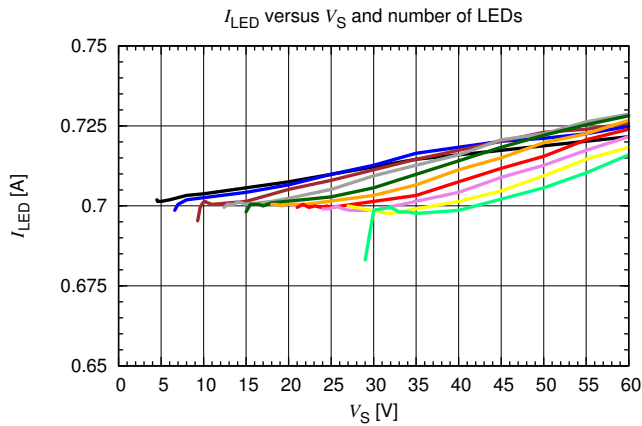
#### 5.4 Switching Parameters

For all shown switching parameters ILD6150 has been measured on evaluation board ILD6150 at  $T_A = 25\text{ }^{\circ}\text{C}$ . Used LEDs have a typical  $V_{ILED}$  of 3 V. Efficiency figure shows total efficiency of the application board including losses of external components as inductor or Schottky diode. See the application note for further details.

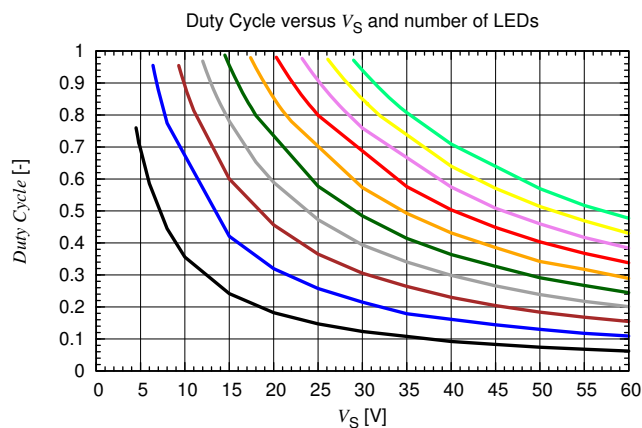
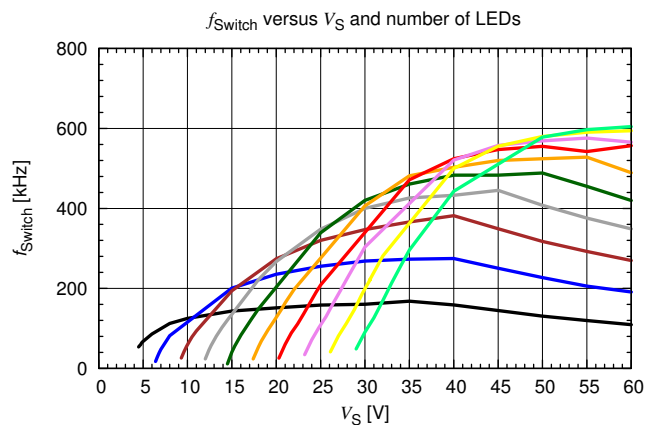
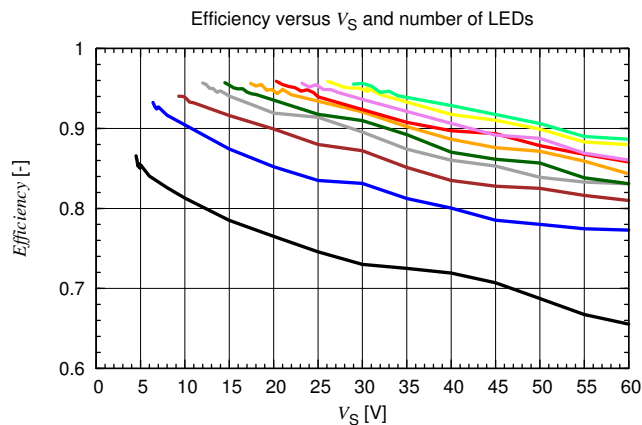
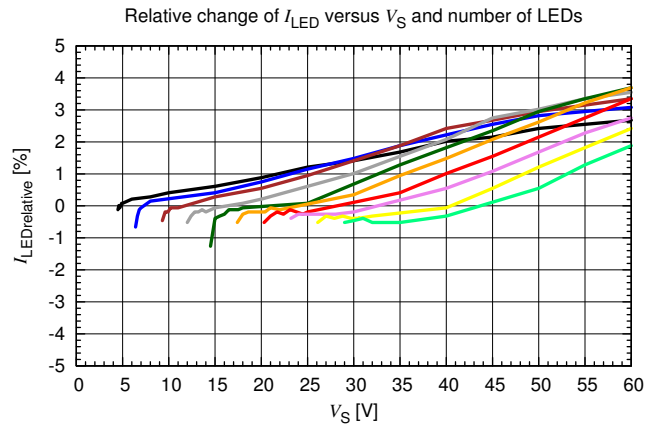
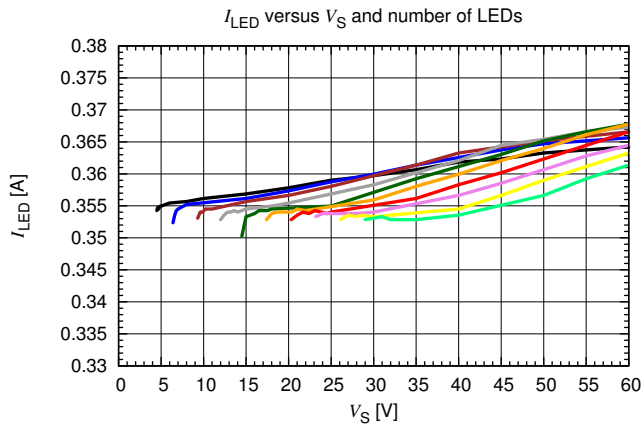
Performance vs. supply voltage and number of LEDs:  $R_{\text{sense}} = 100 \text{ m}\Omega$ ,  $L = 47 \text{ }\mu\text{H}$ ,  $V_{\text{fLED}} = 3 \text{ V}$



Performance vs. supply voltage and number of LEDs:  $R_{\text{sense}} = 213 \text{ m}\Omega$ ,  $L = 68 \text{ }\mu\text{H}$ ,  $V_{\text{fLED}} = 3 \text{ V}$

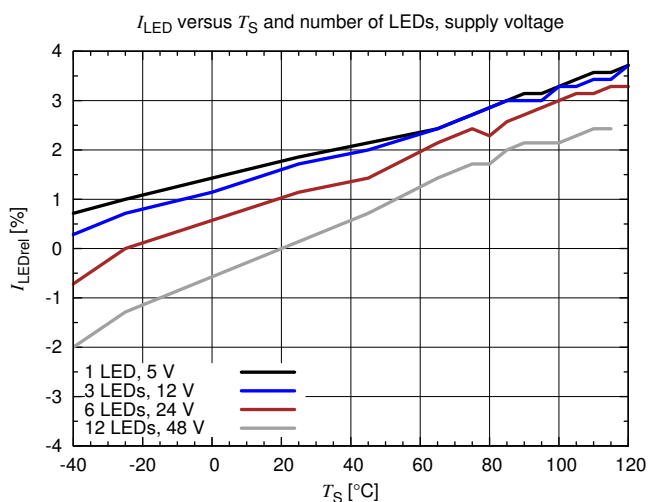
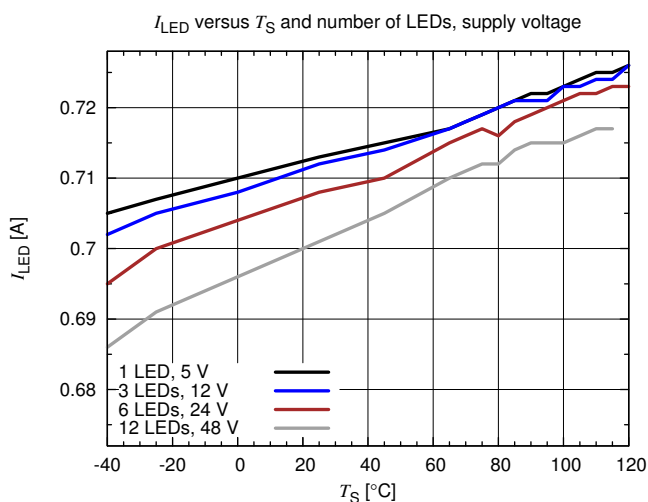


Performance vs. supply voltage and number of LEDs:  $R_{\text{sense}} = 422 \text{ m}\Omega$ ,  $L = 150 \text{ }\mu\text{H}$ ,  $V_{\text{fLED}} = 3 \text{ V}$

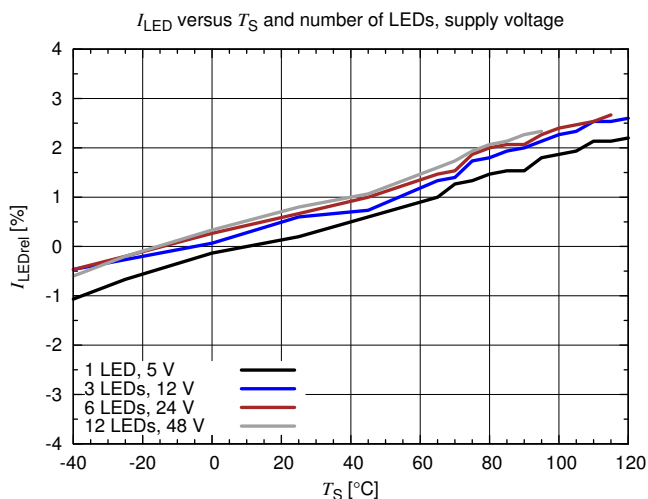
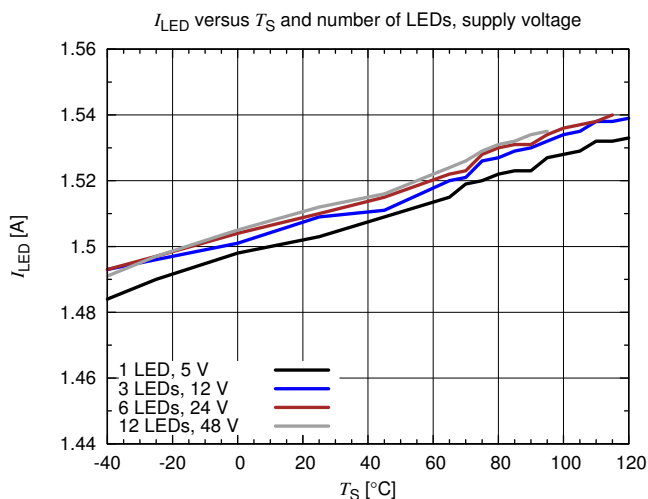


**LED current vs. soldering point temperature:**  $R_{\text{sense}} = 213 \text{ m}\Omega$ ,  $L = 47 \text{ }\mu\text{H}$ ,  $V_{\text{fLED}} = 3 \text{ V}$ ,  $R_{\text{Tadj}} = 0\Omega$ .

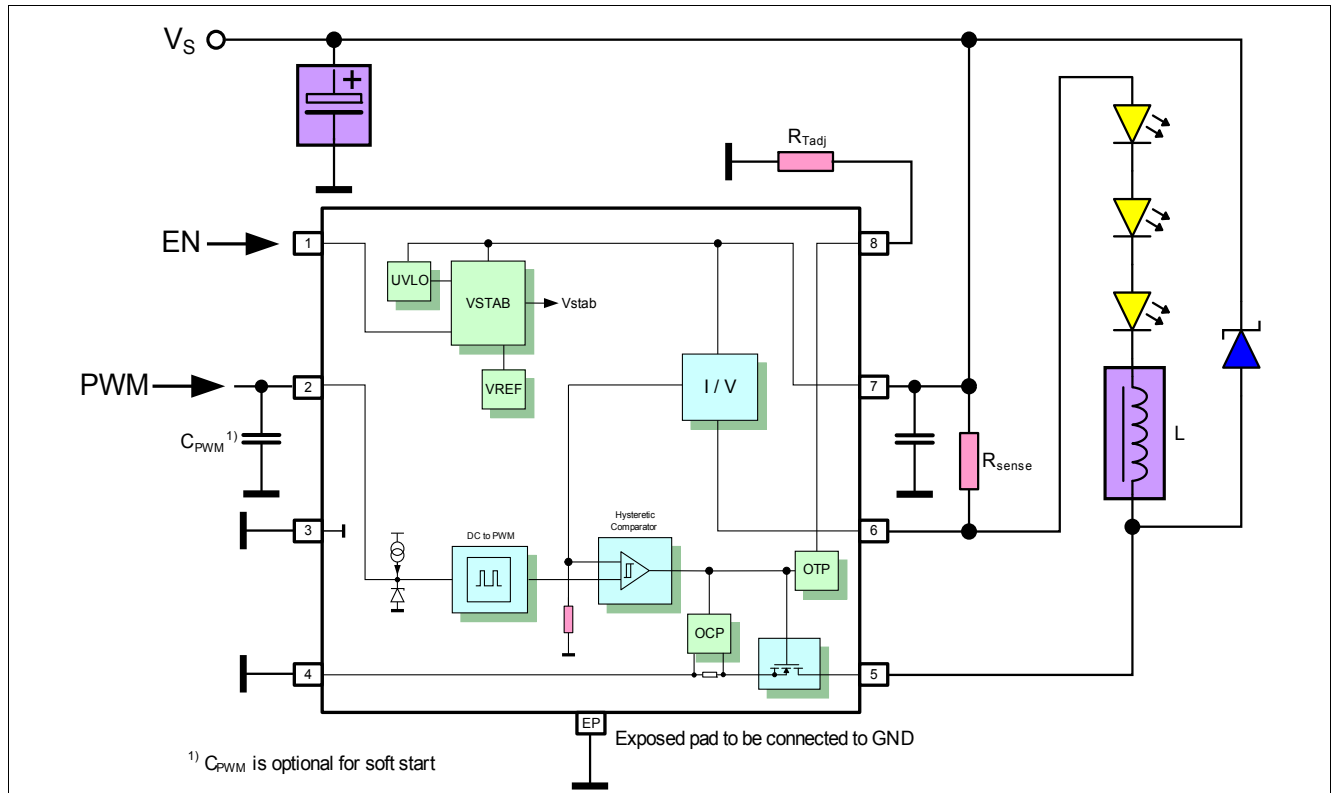
*Note: Soldering point temperature was measured on application PCB close to chip exposed pad. See application note AN-EVAL-ILD6150 for board details. Over temperature protection has been adjusted to max. threshold connecting Tadj pin to GND with  $R_{\text{Tadj}} = 0\Omega$ .*



**LED current vs. soldering point temperature:**  $R_{\text{sense}} = 100 \text{ m}\Omega$ ,  $L = 68 \text{ }\mu\text{H}$ ,  $V_{\text{fLED}} = 3 \text{ V}$ ,  $R_{\text{Tadj}} = 0\Omega$ .



## 6 Application Circuit



**Figure 6 Application Circuit**

A  $V_S$  blocking capacitor shall be placed close to pin 7 to enable a low ripple  $V_{sense}$  measurement and to avoid a false triggering of the  $V_S$  ESD protection element inside the IC.

### 6.1 Setting the average LED current

The average output current for the LEDs is set by the external sense resistor  $R_{sense}$ . To calculate the value of this resistor a first approximation can be calculated using [Equation \(2\)](#).

$V_{sense}$  is slightly dependent on the supply voltage  $V_S$  and the number of LEDs as shown in [Chapter 5.4](#).

$$R_{sense} = \frac{V_{sense}}{I_{LED}} \quad (2)$$

#### Example calculation

$V_S = 12 \text{ V}$ ,  $47 \text{ } \mu\text{H}$ ,  $V_{fLED} = 3 \text{ V}$ , 3 LEDs in series

→  $V_{sense} = 152 \text{ mV}$

$I_{LED} = 1.5 \text{ A}$

→  $R_{sense} = 101 \text{ m}\Omega$

An easy way to achieve these resistor values is to connect standard resistors in parallel.

## 6.2 Inductor Selection Guideline

The inductance of the inductor  $L$ , the supply voltage  $V_s$ , the number of LEDs driven and their average LED current significantly influence the slew rate of the LED current in on and off condition of the LED driver output switch. Due to the hysteretic current control ILD6150 will toggle the output driver stage each time upper or lower current threshold are reached. To maintain best regulation capability of the LED driver it's reasonable to keep a margin to the minimum switch on and off time defined by internal propagation delay times. Disregard of this recommendation by choosing too small inductor values might result in an increased LED current ripple and loss of LED current regulation accuracy.

Minimum 350 ns on and off time are recommended as a reasonable design target for the inductor selection. Below figures provide a guideline concerning minimum inductance value versus supply voltage and number of LEDs. It is assumed that the forward voltage of each LED is within a range of 2.5 V to 3.9 V over temperature and LED production tolerances. Minimum forward voltage (e.g. occurring at high LED temperatures) needs to be considered with respect to the minimum switch on-time while maximum forward voltage (e.g. occurring at low temperatures) needs to be considered with respect to the switch off-time.

The saturation current of the chosen inductor has to be higher than the peak LED current and the rating of its continuous current needs to exceed the average LED current.

0.35 A	Number of LEDs														
$V_s$ [V]	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
5	15														
10	22	33													
15	47	33	47												
20	68	47	47	47	68										
25	68	68	68	47	68	68									
30	100	100	68	68	68	68	100								
35	100	100	100	100	68	68	100	100							
40	150	100	100	100	100	100	100	100	100	150					
45	150	150	150	100	100	100	100	100	100	150	150				
50	150	150	150	150	150	150	100	100	100	150	150	150			
55	150	150	150	150	150	150	150	100	100	150	150	150	150	220	
60	220	220	150	150	150	150	150	150	150	150	150	150	150	220	220

Inductance in  $\mu\text{H}$ ;  $2.5 \text{ V} \leq V_{\text{ILED}} \leq 3.9 \text{ V}$

Figure 7 Minimum Inductance for 0.35 A Average LED Current

0.7 A	Number of LEDs														
$V_s$ [V]	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
5	6.8														
10	10	15													
15	22	15	22												
20	33	22	22	33	33										
25	33	33	33	33	33	47									
30	47	47	33	33	33	47	47								
35	47	47	47	47	33	47	47	47							
40	68	68	47	47	47	47	47	47	68	68					
45	68	68	68	68	47	47	47	47	68	68	68				
50	68	68	68	68	68	68	47	47	68	68	68	68			
55	100	100	68	68	68	68	68	68	68	68	68	68	100		
60	100	100	100	100	68	68	68	68	68	68	68	68	100	100	100

Inductance in  $\mu\text{H}$ ;  $2.5 \text{ V} \leq V_{\text{ILED}} \leq 3.9 \text{ V}$

Figure 8 Minimum Inductance for 0.7 A Average LED Current



1.5 A	Number of LEDs														
V <sub>s</sub> [V]	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
5	4.7														
10	6.8	10													
15	10	10	10												
20	15	10	10	15											
25	15	15	15	15	15	22									
30	22	22	15	15	15	22	22								
35	22	22	22	22	15	22	22	22							
40	33	33	22	22	22	22	22	22	33	33					
45	33	33	33	33	22	22	22	22	33	33	33				
50	33	33	33	33	33	33	33	22	33	33	33	33			
55	47	33	33	33	33	33	33	33	33	33	33	33	47		
60	47	47	47	33	33	33	33	33	33	33	33	33	47	47	47

Inductance in  $\mu\text{H}$ ;  $2.5 \text{ V} \leq V_{\text{fLED}} \leq 3.9 \text{ V}$

Figure 9 Minimum Inductance for 1.5 A Average LED Current

## 7 Package Information

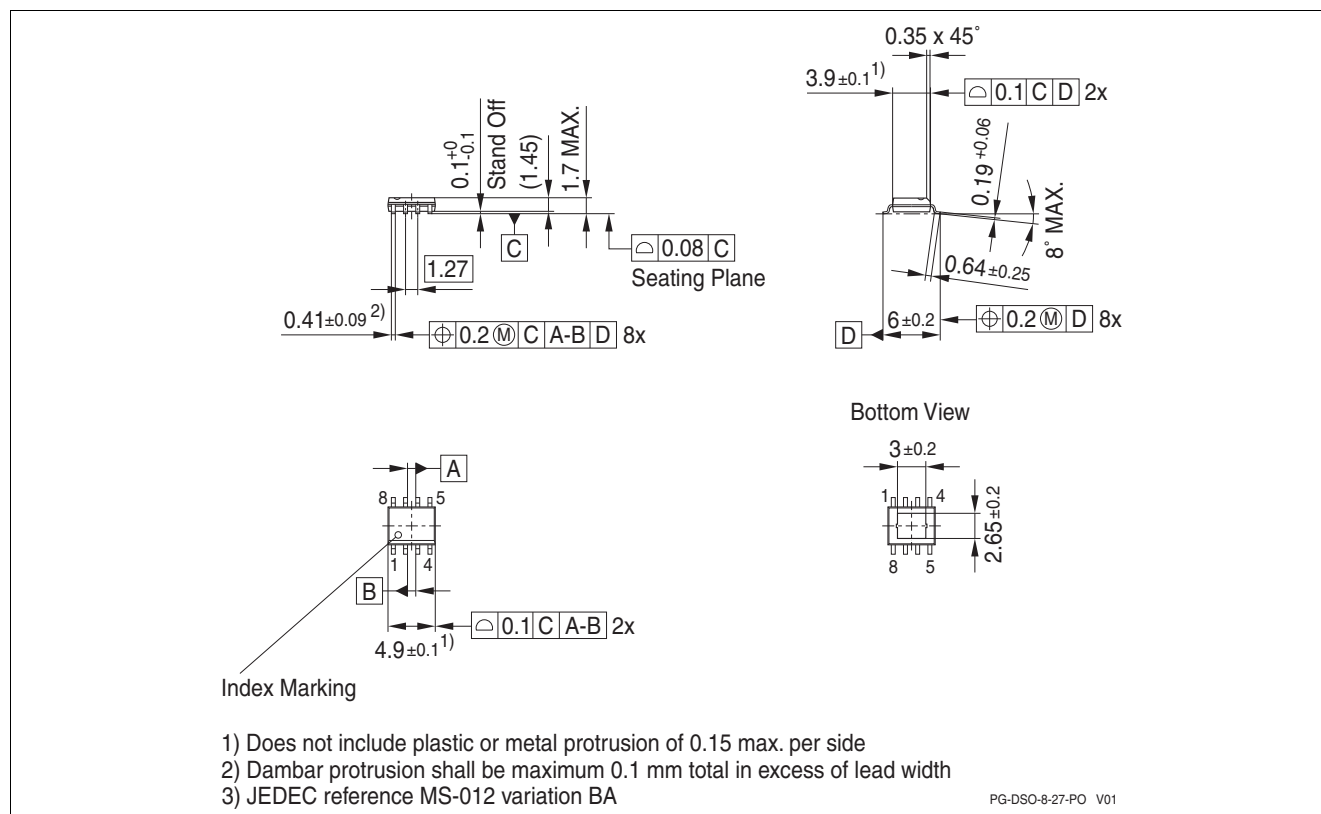


Figure 10 Package outline PG-DSO-8-27 (dimensions in mm)

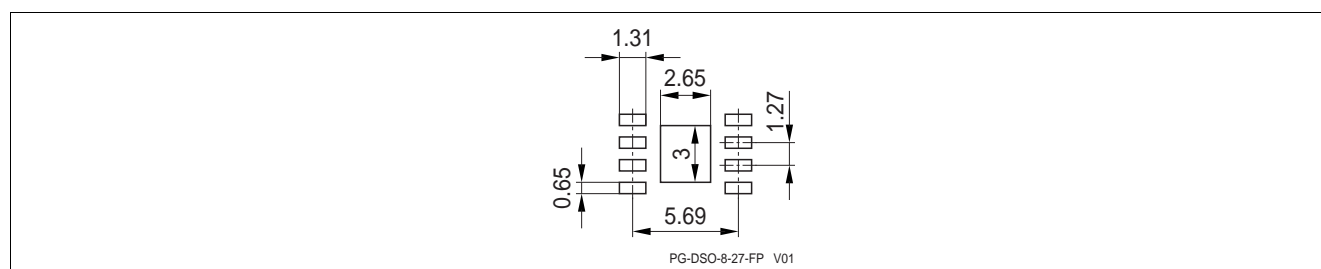


Figure 11 Recommended PCB Footprint for Reflow Soldering (dimensions in mm)

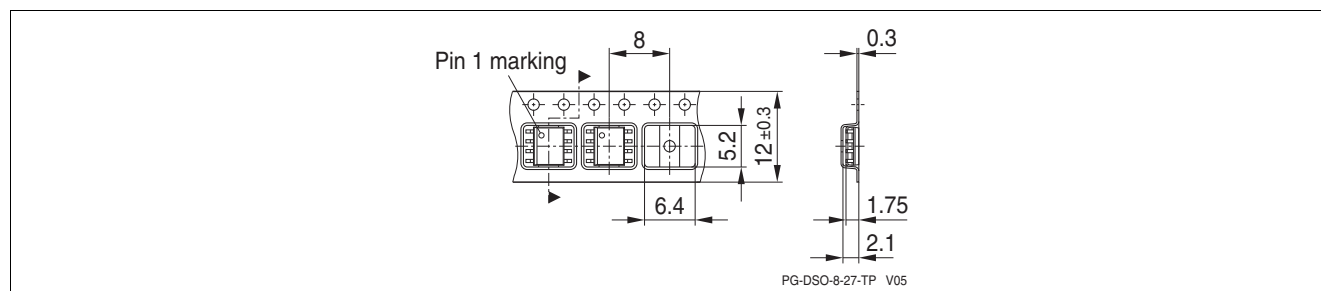


Figure 12 Tape Loading (dimensions in mm)

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